

Docket No.: 3008-0016
File No. 521.41450X00
Client No.: PHCF-00189

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

O I P E
JUL 29 2002
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U.S. PATENT AND TRADEMARK OFFICE
On re Application of

Matsui et al.

Application S/N: 09/758,268

Filed: January 12, 2001

: Group Art Unit: 1742

: Examiner: S. Ip

10/B

PL 102

For: ULTRAFINE COPPER ALLOY WIRE, STRANDED COPPER ALLOY WIRE,
CONDUCTOR, EXTRAFINE COAXIAL CABLE, AND PROCESS FOR PRODUCING
ULTRAFINE COPPER ALLOY WIRE

AMENDMENT

Honorable Assistant Commissioner
for Patents
Washington, DC 20231

Sir:

In response to the Official Action dated March 27, 2002, the time for response to which has been extended one month, up to and including July 27, 2002, please amend the above-referenced application as follows.

IN THE CLAIMS

Please cancel claims 12-14.

Please add new claims 15-27 as follows.

--15. The ultrafine copper alloy wire according to claim 2, wherein said copper alloy wire has thereon a tin plating, a silver plating, a nickel plating, a tin-lead solder plating, a tin-silver plating, a tin-copper plating, a tin-silver-copper plating, or a tin-silver-copper-bismuth plating.

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